

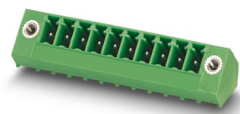
SMC 1,5/10-GF-3,81 - PCB header

1827509

<https://www.phoenixcontact.com/us/products/1827509>



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PCB headers, nominal cross section: 1.5 mm², color: green, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Tin, contact connection type: Pin, number of potentials: 10, number of rows: 1, number of positions: 10, number of connections: 10, product range: SMC 1,5/...-GF, pitch: 3.81 mm, mounting: Wave soldering, pin layout: Linear pinning, solder pin [P]: 3.4 mm, number of solder pins per potential: 1, plug-in system: COMBICON MC 1,5, Pin connector pattern alignment: Standard, locking: Screw locking mechanism, mounting: Threaded flange, type of packaging: packed in cardboard

Your advantages

- Well-known mounting principle allows worldwide use
- Screwable flange for superior mechanical stability
- Angled connection enables multi-row arrangement on the PCB
- Maximum flexibility when it comes to device design – one header for connectors with different connection technologies

Commercial data

Item number	1827509
Packing unit	50 pc
Minimum order quantity	50 pc
Note	Made to order (non-returnable)
Sales key	AA02
Product key	AABSSB
Catalog page	Page 229 (C-1-2013)
GTIN	4017918114602
Weight per piece (including packing)	4.06 g
Weight per piece (excluding packing)	3.61 g
Customs tariff number	85366930
Country of origin	DE

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Technical data

Product properties

Product type	PCB headers
Product family	SMC 1,5/...-GF
Product line	COMBICON Connectors S
Type	Standard
Number of positions	10
Pitch	3.81 mm
Number of connections	10
Number of rows	1
Number of potentials	10
Mounting flange	Threaded flange
Pin layout	Linear pinning
Solder pins per potential	1

Electrical properties

Nominal current I_N	8 A
Nominal voltage U_N	160 V
Degree of pollution	3
Contact resistance	1.7 mΩ
Rated voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV

Mounting

Mounting type	Wave soldering
Pin layout	Linear pinning

Flange

Tightening torque	0.3 Nm
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Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (5 - 7 μm Sn)
Metal surface contact area (middle layer)	Nickel (2 - 3 μm Ni)
Metal surface soldering area (top layer)	Tin (5 - 7 μm Sn)

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Metal surface soldering area (middle layer)	Nickel (2 - 3 µm Ni)
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Material data - housing

Color (Housing)	green (6021)
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

Dimensions

Dimensional drawing	
Pitch	3.81 mm
Width [w]	48.49 mm
Height [h]	14.4 mm
Length [l]	13.11 mm
Installed height	11 mm
Solder pin length [P]	3.4 mm
Pin dimensions	0.8 x 0.8 mm

PCB design

Hole diameter	1.2 mm
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Mechanical tests

Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

Polarization and coding

Specification	IEC 60512-13-5:2006-02
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Result	Test passed
Contact holder in insert	
Specification	IEC 60512-15-1:2008-05
Contact holder in insert Requirements >20 N	Test passed
Insertion and withdrawal forces	
Result	Test passed
No. of cycles	25
Insertion strength per pos. approx.	7 N
Withdraw strength per pos. approx.	4 N

Electrical tests

Thermal test Test group C	
Specification	IEC 60512-5-1:2002-02
Tested number of positions	16

Insulation resistance	
Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

Air clearances and creepage distances	
Specification	IEC 60664-1:2007-04
Insulating material group	I
Comparative tracking index (IEC 60112)	CTI 600
Rated insulation voltage (III/3)	160 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	2.5 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.5 mm
Rated insulation voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	2 mm

Environmental and real-life conditions

Vibration test	
Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)

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Acceleration	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h

Durability test

Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	2.95 kV
Contact resistance R ₁	1.7 mΩ
Contact resistance R ₂	1.8 mΩ
Insertion/withdrawal cycles	25

Climatic test

Specification	ISO 6988:1985-02
Corrosive stress	0.2 dm ³ SO ₂ on 300 dm ³ /40 °C/1 cycle
Thermal stress	100 °C/168 h
Power-frequency withstand voltage	1.39 kV

Shocks

Specification	IEC 60068-2-27:2008-02
Pulse shape	Half-sine
Acceleration	30g
Shock duration	18 ms
Test directions	X-, Y- and Z-axis (pos. and neg.)

Ambient conditions

Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)
Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C

Packaging specifications

Type of packaging	packed in cardboard
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